



Peak pulse voltage ( $T_j=25$ ; non-repetitive, off-state; FIG.7)	$V_{pp}$	4	kV
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## ELECTRICAL CHARACTERISTICS (unless otherwise specified)

Symbol	Test Condition	Quadrant	Value		Unit
$I_{GT}$	$V_D=12V$ $R_L=33$	- -	MAX.	35	mA
$V_{GT}$		- -	MAX.	1	V
$V_{GD}$	$V_D=V_{DRM}$ $T_j=150$ $R_L=3.3k$	- -	MIN.	0.2	V
$I_L$	$I_G=1.2I_{GT}$	-	MAX.	40	mA
				50	
$I_H$	$I_T=100mA$		MAX.	30	mA
$dV/dt$	$V_D=400V$ Gate Open $T_j=150$		MIN.	1200	V/s
$(dI/dt)_c$	$V_D=150V$ $T_j=150$		MIN.	8	A/ms
$t_{on}$	$I_G=40mA$ $I_A=200mA$ $I_R=20mA$ $T_j=25$		TYP.	3	s
$t_{off}$				30	

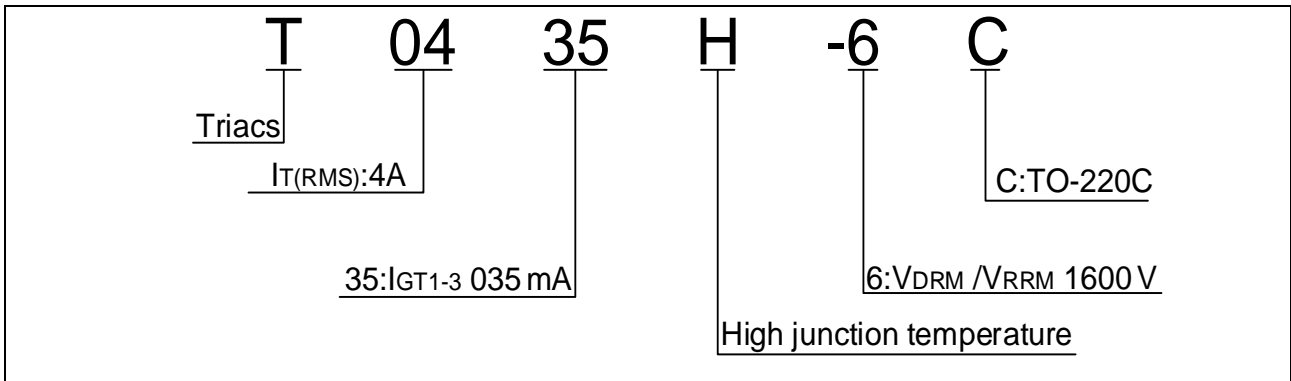
## STATIC CHARACTERISTICS

Symbol	Parameter		Value(MAX.)	Unit
$V_{TM}$	$I_{TM}=5.5A$ $t_p=380$ s	$T_j=25$	1.4	V
$V_{TO}$	Threshold voltage	$T_j=150$	0.6	V
$R_D$	Dynamic resistance	$T_j=150$	129	P
$I_{DRM}$	$V_D=V_{DRM}$ $V_R=V_{RRM}$	$T_j=25$	5	A
$I_{RRM}$		$T_j=150$	0.8	mA

## THERMAL RESISTANCES

Symbol	Parameter	Value	Unit
$R_{th(j-c)}$	junction to case (AC)	2	$^{\circ}W$
$R_{th(j-a)}$	junction to ambient (AC)	60	$^{\circ}W$

ORDERING INFORMATION



MARKING

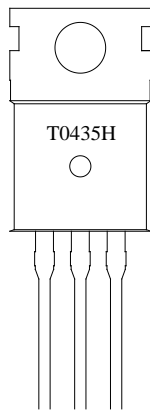


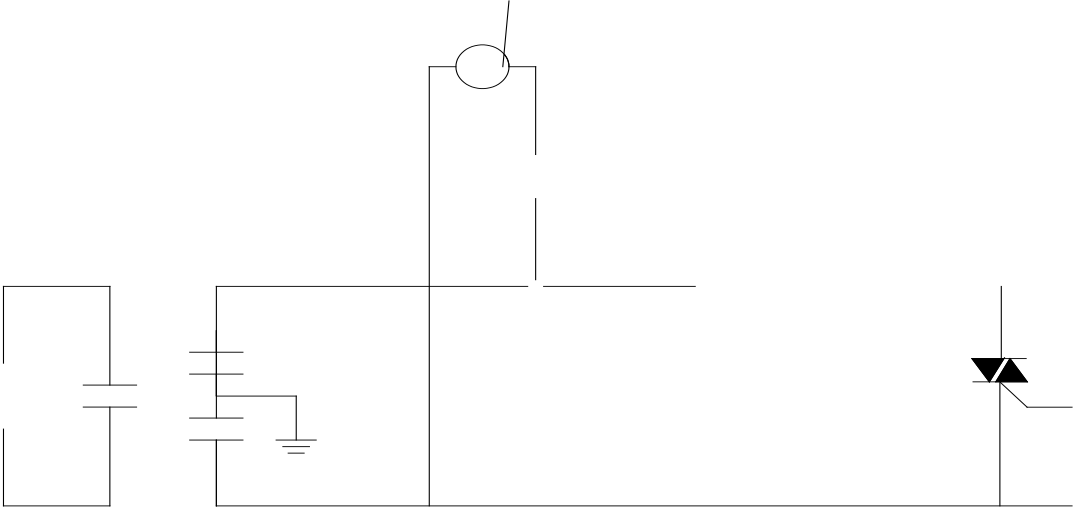
FIG.1: Maximum power dissipation versus RMS on-state current

FIG.2: RMS on-state current versus case temperature

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FIG.7 ÖTest circuit for inductive and resistive loads to IEC-61000-4-5 standards



## ORDERING INFORMATION

Order code	Voltage $V_{DRM}/V_{RRM}$ (V)	IGT(mA)	Package	Base qty. (pcs)	Delivery mode
		- -			
T0435H-6C	600	35	TO-220C	50	Tube

## Document Revision History

Date	Revision	Changes
Apr.10, 2023	A.1.0	Last updated
Oct.14, 2025	A.1.1	Revise PACKAGE MECHANICAL DATA

PACKAGE MECHANICAL DATA



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